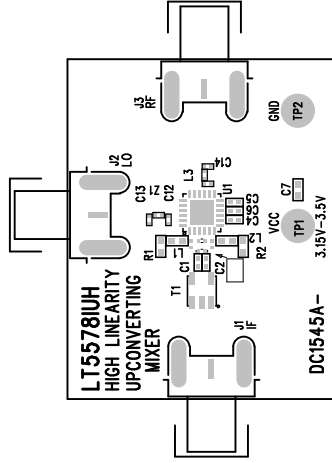
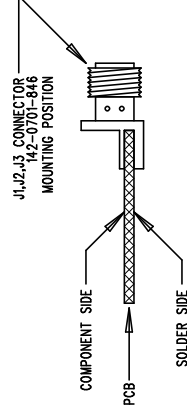



1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. INSERT SMA CONNECTORS FLUSH AGAINST BOARD EDGE.
3. ASSY PROCESSES SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
HAND SOLDER BOTTOM SIDE SMD.
HAND SOLDER BOTTOM THRU-HOLE COMPONENTS.
4. PARTS TO OMIT WILL BE SPECIFIED ON THE PARTS LIST.
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
5. SHORTAGES SHALL EXIST ON THE MINIMUM NUMBER OF BOARDS.
6. DO NOT OTHERWISE MARK BOARDS (e.g. NO QA-STAMP).
7. DEPANELIZE BOARDS AFTER ASSEMBLY.
8. THE VENDOR SHOULD ASSEMBLE ALL THE PARTS DEFINED IN THE BILL OF MATERIAL INCLUDING HAND SOLDER COMPONENTS.
9. THE VENDOR SHOULD ALSO MARK THE VERSION A, B OR C AND SO ON IN THE WHITE BLANK SPACE ON THE SILKSCREEN FOLLOWING THE BOM INSTRUCTION.



Assembly Top Drawing



APPROVALS			 LINEAR TECHNOLOGY 1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
	INIT	DATE	TITLE: LT57578UH HIGH LINEARITY UPCONVERTING MIXER	
DRAWN				
CHECK				
DESIGN	Helen	2/23/09		
ENGR	SUNNY H.	2/23/09		
			SIZE	A DEMO DC1545A-A/B REV. A
			DCS-250 SCALE = NONE SHT 1 of 1	